



Top and Side Views

△1 Substrate: 0.0625"±0.007" FR4/G10 or equivalent high temp material. 1/2 oz. Cu clad. SnPb plating

△2 Pins: Material- Brass Alloy 360 1/2 hard; finish- 10μ" Au over 50μ" Ni (min.).

△3 Pins: shell material- Brass Alloy 360 1/2 hard; finish- 10μ" Au over 50μ" Ni (min.). Contact material- BeCu; finish 10μ" Au over 100μ" Ni (min.).

**PC-DIP/DIP16-01 Drawing**

Status: Released

Scale: 4:1

Rev: B



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ECO#